



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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## Data and signal line chokes

Common-mode chokes, ring core  
2.2 ... 47 mH, 100 mA, +60 °C

**Series/Type:** B82791G15/H15

**Date:** October 2008, October 2011

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**Rated voltage 42 V AC/80 V DC**

**Rated inductance 2.2 mH to 47 mH**

**Rated current 100 mA**

### Construction

- Current-compensated ring core double choke
- Ferrite core
- Polycarbonate case (UL 94 V-0)

### Features

- Without potting
- Vertical or horizontal version
- Suitable for wave soldering
- RoHS-compatible

### Application

Suppression of asymmetrical interference coupled in on data lines, already effective at 10 kHz, e.g. in:

- Telephone lines (analog, ISDN)
- Interfaces with symmetrical data transmission
- Building services automation (EIB bus)
- Automation engineering

### Terminals

- Base material CuNi18Zn20
- Layer composition Ni, Sn
- Hot-dipped
- Lead spacing 10 × 15 (mm) or 12.7 × 5.08/2.54 (mm)

### Marking

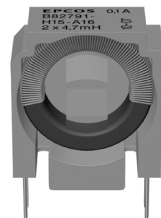
Manufacturer, ordering code, rated inductance, rated current, graphic symbol (for B82791G15), date of manufacture (MMYY)

### Delivery mode

Cardboard box



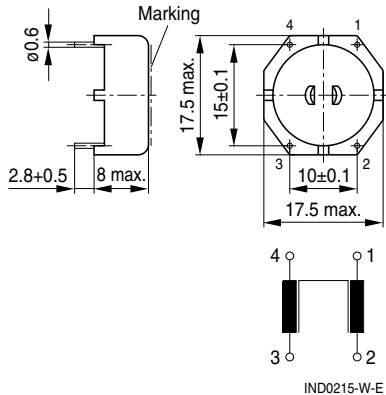
B82791G15



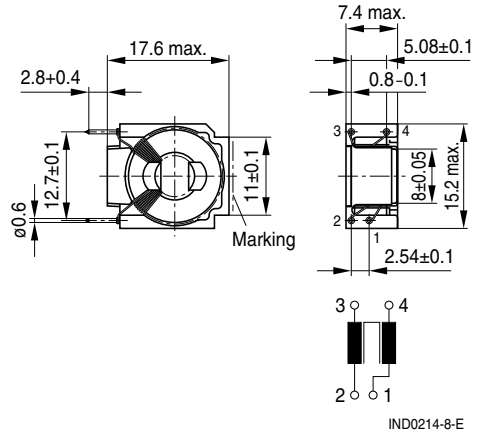
B82791H15

**Dimensional drawings and pin configurations**

Horizontal version (B82791G15)



Vertical version (B82791H15)


 Tolerances to ISO 2768-M unless otherwise noted.  
 Dimensions in mm.

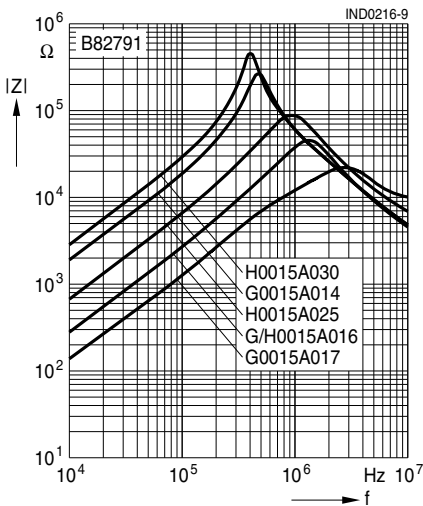
**Technical data and measuring conditions**

|  |   |
|--|---|
| Rated voltage $V_R$                              | 42 V AC (50/60 Hz) / 80 V DC  |
| Rated temperature $T_R$                          | +60 °C  |
| Rated current $I_R$                              | Referred to 50 Hz and rated temperature   |
| Rated inductance $L_R$                           | Measured with Agilent 4284A at 10 kHz, 0.1 mA, +20 °C<br>Inductance is specified per winding.                 |
| Inductance tolerance                             | ±30% at +20 °C<br>B82791H0015A016: -25/+35% at +20 °C   |
| Inductance decrease $\Delta L/L_0$               | < 10% at DC magnetic bias with $I_R$ , +20 °C   |
| Stray inductance $L_{\text{stray,typ}}$          | Measured with Agilent 4275A at 10 kHz, 5 mA, +20 °C,<br>typical values  |
| DC resistance $R_{\text{typ}}$                   | Measured at +20 °C, typ. values, specified per winding  |
| Solderability (lead-free)                        | Sn96.5Ag3.0Cu0.5: (+245 ±5) °C, (3 ±0.3) s<br>Wetting of soldering area ≥ 95%<br>(to IEC 60068-2-20, test Ta) |
| Resistance to soldering heat<br>(wave soldering) | (+260 ±5) °C, (10 ±1) s<br>(to IEC 60068-2-20, test Tb)   |
| Climatic category                                | 40/125/56 (to IEC 60068-1)  |
| Storage conditions (packaged)                    | -25 °C ... +40 °C, ≤ 75% RH   |
| Weight   | Approx. 3 g   |

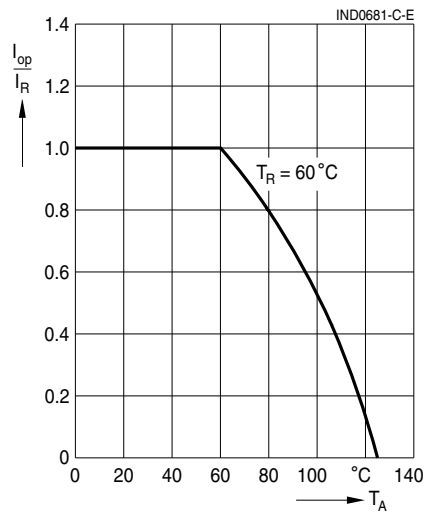
**Characteristics and ordering codes**

| $L_R$<br>mH | $L_{\text{stray,typ}}$<br>nH | $I_R$<br>mA | $R_{\text{typ}}$<br>m $\Omega$ | $V_{\text{test}}$<br>V DC, 2 s | Ordering code      |                  |
|-------------|------------------------------|-------------|--------------------------------|--------------------------------|--------------------|------------------|
|             |                              |             |                                |                                | horizontal version | vertical version |
| 2.2         | 500                          | 100         | 300                            | 1200                           | B82791G0015A017    | —                |
| 4.7         | 900                          | 100         | 850                            | 1200                           | B82791G0015A016    | B82791H0015A016  |
| 10          | 1200                         | 100         | 1200                           | 1200                           | —                  | B82791H0015A025  |
| 38          | 3300                         | 100         | 5000                           | 750                            | B82791G0015A014    | —                |
| 47          | 2100                         | 100         | 5100                           | 750                            | —                  | B82791H0015A030  |

**Impedance  $|Z|$  versus frequency  $f$**   
measured with windings in parallel at 20 °C,  
typical values



**Current derating  $I_{\text{op}}/I_R$**   
**versus ambient temperature**



## Cautions and warnings

### Current-compensated ring core double chokes

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
  - Particular attention should be paid to the derating curves given there. Derating must be applied in the case the ambient temperature in application exceeds the rated temperature of the component.
  - Ensure the operation temperature of the component in application, which is the sum of the ambient temperature and the temperature rise owing to losses ("self-heating"), not to exceed the maximum value specified in the climatic category.
  - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
- The following points must be observed if the components are potted in customer applications:
  - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
  - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
  - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

## Important notes

### Current-compensated ring core double chokes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
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3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet ([www.epcos.com/material](http://www.epcos.com/material)). Should you have any more detailed questions, please contact our sales offices.
5. We constantly strive to improve our products. Consequently, **the products described in this publication may change from time to time**. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order.

We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available.

The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

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